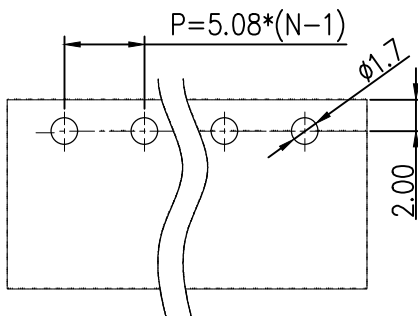
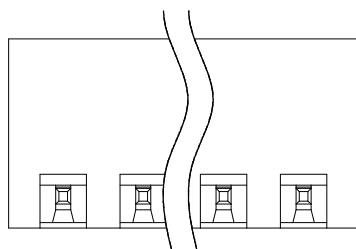
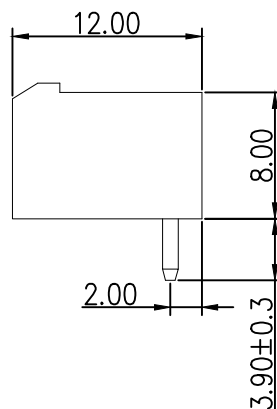
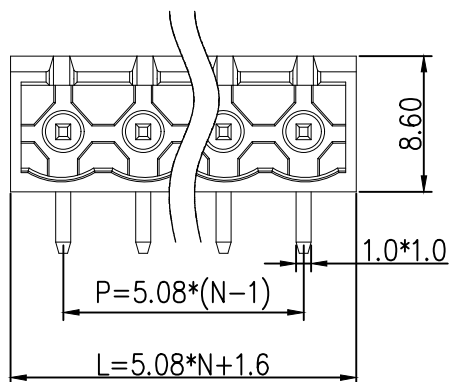
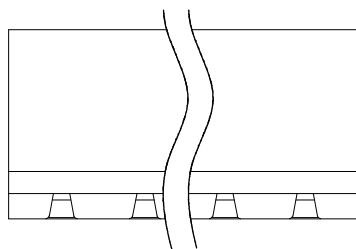


标 记  
MARKECN编号/变更内容  
ECN NO/DEFINITION修 改  
REVISE日 期  
DATE核 准  
APPROVE

PCB LAYOUT

## Materials and Electroplating

①. Plastic body: PA66

②. Solder pin: copper, nickel tin plated

Electrical performance

Rated voltage: 300V

Rated current: 15A

Contact resistance: 20m Ω (Max)

Insulation resistance: 500M Ω \ DC500V

Voltage endurance: AC1500V \ 1Min

mechanical properties

Temperature range: -40 °C~+105 °C

Instantaneous temperature: +250 °C, 5 seconds

| 2  | 插针 | 铜    | 镀镍锡   |    |
|----|----|------|-------|----|
| 1  | 基座 | PA66 | 绿色    |    |
| 序号 | 品名 | 材质   | 电镀/颜色 | 备注 |



深圳市虹成电子有限公司

|               |                   |
|---------------|-------------------|
| 品名<br>TITLE   | 接线端子              |
| 料号<br>PART NO | HC-JXDZRC-5.08-9P |

GENERAL TOLERANCES  
(UNLESS SPECIFIED)比 例  
SCALE

1:1

| 公差     | 公差参数        |
|--------|-------------|
| 2-6P   | ±0.10 ±0.20 |
| 7-12P  | ±0.20 ±0.30 |
| 13-18P | ±0.25 ±0.40 |
| 19-24P | ±0.30 ±0.50 |

X. xxx ±0.15

X. xx ±0.25

X. x ±0.35

单 位  
UNIT

MM

张 数  
PART NO

1 OF 1

版 本  
REV

A

制 图  
DRAW

AhYe

审 核  
CHECKED

夏操云

批 准  
APPROVE

赵亮亮

